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A Small Package Proximity Sensor With a VCSEL, Low Idle Current, I²C Interface, and Smart Dual Slave Address



DESCRIPTION

The VCNL36828P is a fully integrated proximity sensor. It combines a vertical-cavity surface-emitting laser (VCSEL), photodiode, and application-specific integrated circuit (ASIC) within a single package. The VCNL36828P has been developed for proximity detection applications that require a dual slave address, low power consumption, small package size, small window size, and short range operation. In addition, given the typical rated supply voltage of 1.8 V to reduce power consumption, the sensor is intended for battery-powered applications.

FEATURES

- Package type: surface-mount
- Dimensions (L x W x H in mm): 2.0 x 1.0 x 0.5
- Integrated modules: vertical-cavity surfaceemitting laser (VCSEL), photodiode, and application-specific integrated circuit (ASIC)
- 1.8 V rated power supply and I²C bus
- \bullet Low power consumption with 5 μA idle current
- A small package allows a design with a small window size
- Smart dual I2C slave address in one package
- Immunity to red glow (940 nm VCSEL)
- Programmable I_{VCSEL} sink current
- Intelligent cancellation to reduce cross talk phenomenon
- Smart persistence scheme to reduce measurement response time
- · Interrupt functionality
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Smartphones and true wireless stereo (TWS) earbuds
- VR / AR headsets and smart glasses
- Smartwatches
- · Touchless button / dispensing

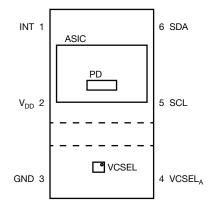
PRODUCT SUMMARY										
PART NUMBER	OPERATING RANGE (mm)	OPERATING VOLTAGE RANGE (V)	I ² C BUS VOLTAGE RANGE (V)	MAX. VCSEL DRIVING CURRENT (mA)	OUTPUT CODE	ADC RESOLUTION PROXIMITY / AMBIENT LIGHT				
VCNL36828P	200	1.65 to 2.00	1.2 to 3.6	20	12 bit / 16 bit, I ² C	16 bit / -				

ORDERING INFORMATION								
ORDERING CODE	PACKAGING	VOLUME (1)	REMARKS					
VCNL36828P	Tape and reel	MOQ: 5000 pcs, 5000 pcs/reel	2.0 mm x 1.0 mm x 0.5 mm					

Note

(1) MOQ: minimum order quantity





PIN DESCRIPTION			
PIN NUMBER	PIN NAME	TYPE	DESCRIPTION
1	INT	O (open drain)	Interrupt
2	V _{DD}	I	Supply voltage
3	GND	I	Ground
4	VCSELA	I	VCSEL anode
5	SCL (1)	I / O (open drain)	I ² C serial clock
6	SDA (1)	I / O (open drain)	I ² C serial data

Note

⁽¹⁾ Pin 5 (SCL) and pin 6 (SDA) can be swapped to change the slave address from 0x60 to 0x51; please refer to Table 1

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)									
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT				
Supply voltage		V _{DD}	0	2	V				
Ambient temperature range		T _{amb}	-40	+85	°C				
Storage temperature range		T _{stg}	-40	+100	°C				

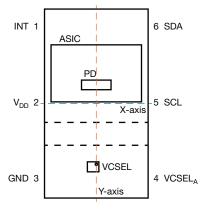


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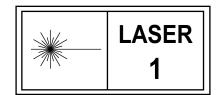
BASIC CHARACTERISTIC	S ($T_{amb} = 25 ^{\circ}C$, unless otherwise specifi	ed)				
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
ASIC						
Supply voltage		V_{DD}	1.65	1.80	2.00	V
(4)	Shutdown state; light condition = dark; $V_{DD} = 1.8 \text{ V}$		-	1	-	
Supply current (1)	Idle state (2); V _{DD} = 1.8 V	I _{DD}	=.	5	=.	μΑ
	Active state (2); V _{DD} = 1.8 V		=	330	-	
I ² C supply voltage		V _{PULL UP}	1.2	1.8	3.6	V
I ² C signal input, logic high	V _{DD} = 1.8 V	V _{IH}	1	-		V
I ² C signal input, logic low	V _{DD} = 1.8 V	V _{IL}	-	-	0.5	V
VCSEL						
Supply voltage of the VCSEL (3)		V _{VCSEL}	2.62	-	3.60	V
Forward voltage	I _F = 9 mA	V _F	-	1.92	-	V
Forward current		I _F	7	-	20	mA
Angle of half intensity		φ	-	± 4.5	-	0
Peak wavelength	I _F = 9 mA	λ_{p}	-	940	-	nm
Spectral bandwidth	I _F = 9 mA	Δλ	-	3	-	nm
PHOTODIODE						
Annala of half agenticity	X-axis (4)		-	± 60	-	0
Angle of half sensitivity	Y-axis (4)	φ	-	± 45	-	1
Peak sensitivity wavelength		λ_{p}	-	850	-	nm

Notes

- (1) Actual current consumption depends on the register settings. Please refer to the application note on the current consumption
- (2) Excluding VCSEL driving current
- (3) V_{VCSEL} should at least match the minimum required supply voltage for the VCSEL V_{VCSEL, min}. Please refer to the V_{VCSEL, min} table
- (4) Cross section of the package



V _{VCSEL, MIN}	٧.							
I_VCSEL (I _F)	7 mA	9 mA	11 mA	12 mA	15 mA	17 mA	19 mA	20 mA
V _{VCSEL, min.}	2.62 V	2.74 V	2.86 V	2.91 V	3.08 V	3.19 V	3.3 V	3.36 V
V _{VCSEL, max.}		3.6 V						

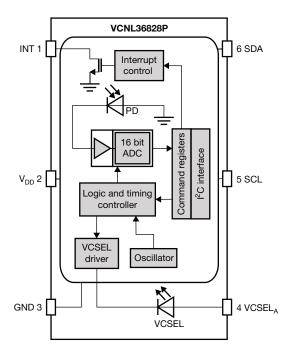


Note

• Product specification with IEC / EN 60825-1:2014 compliance and above label

BLOCK DIAGRAM

LASER CLASS





I ² C BUS TIMING CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)										
DADAMETED	SYMBOL	STANDA	RD MODE	FAST	UNIT					
PARAMETER	STIMBUL	MIN.	MAX.	MIN.	MAX.	UNII				
Clock frequency	f _(I2CCLK)	10	100	10	400	kHz				
Bus free time between start and stop condition	t _(BUF)	4.7	-	1.3	-	μs				
Hold time after (repeated) start condition; after this period, the first clock is generated	t _(HDSTA)	4.0	-	0.6	-	μѕ				
Repeated start condition setup time	t _(SUSTA)	4.7	-	0.6	-	μs				
Stop condition setup time	t _(SUSTO)	4.0	-	0.6	-	μs				
Data hold time	t _(HDDAT)	0	3450	0	900	ns				
Data setup time	t _(SUDAT)	250	-	100	-	ns				
I ² C clock (SCL) low period	t _(LOW)	4.7	-	1.3	-	μs				
I ² C clock (SCL) high period	t _(HIGH)	4.0	-	0.6	-	μs				
Clock / data fall time	t _(f)	-	300	-	300	ns				
Clock / data rise time	t _(r)	-	1000	-	300	ns				

Note

• Data based on standard I²C protocol requirement, not tested in production

(SCL)

I²C BUS DATA (SDA)

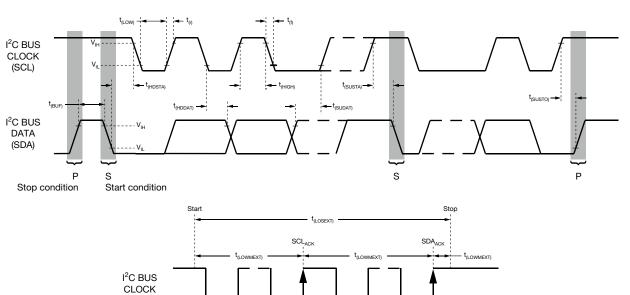


Fig. 1 - I²C Bus Timing Diagram

PARAMETER TIMING INFORMATION

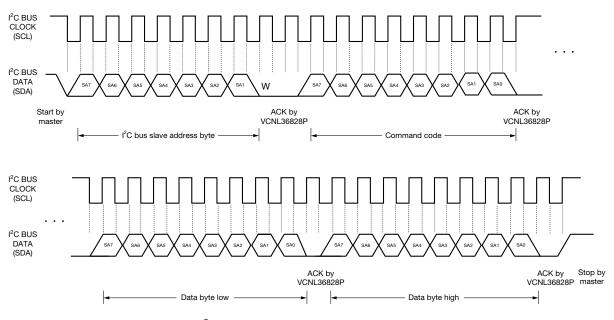


Fig. 2 - I²C Bus Timing for Sending Word Command Format

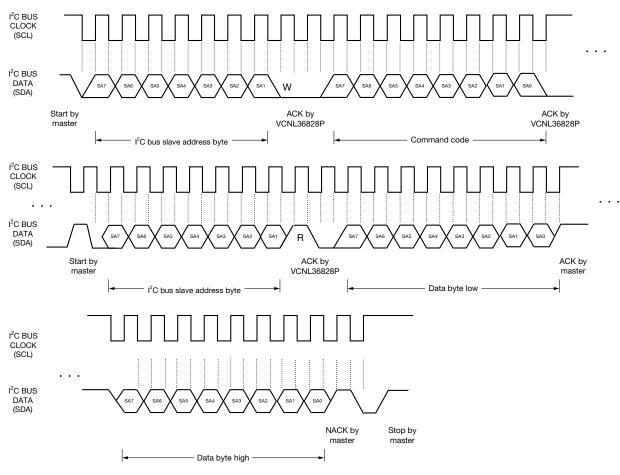


Fig. 3 - I²C Bus Timing for Receiving Word Command Format

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TYPICAL PERFORMANCE CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

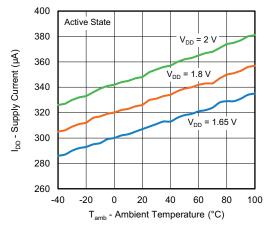


Fig. 4 - Supply Current vs. Ambient Temperature

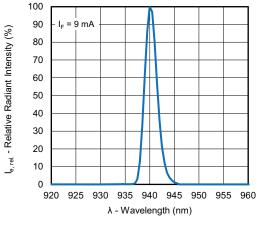


Fig. 7 - Relative Radiant Intensity vs. Wavelength of the VCSEL

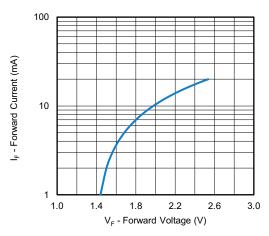


Fig. 5 - Forward Current vs. Forward Voltage of the VCSEL

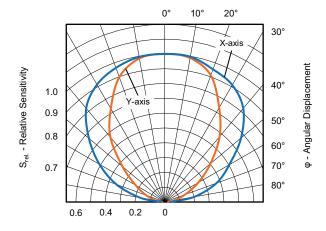


Fig. 8 - Relative Sensitivity vs. Angular Displacement of the Photodiode

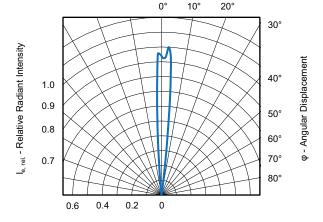


Fig. 6 - Relative Radiant Intensity vs. Angular Displacement of the VCSEL

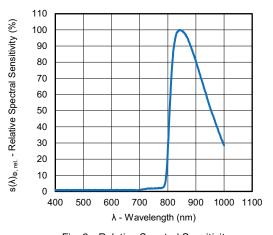


Fig. 9 - Relative Spectral Sensitivity vs. Wavelength of the Photodiode



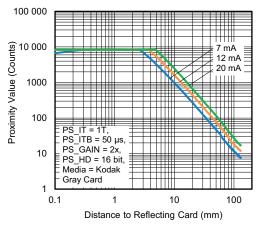


Fig. 10 - Proximity Value vs. Distance

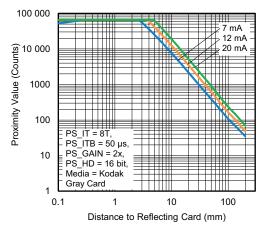


Fig. 11 - Proximity Value vs. Distance

APPLICATION INFORMATION

7 Bit Slave Address Selection

The VCNL36828P supports a smart dual slave address where the designer can change the 7 bit slave address by swapping the SCL and SDA pins, as shown in Table 1.

TABLE 1 - SLAVE ADDRESS TABLE								
PIN 5	N 5 PIN 6 7 BIT SLAVE ADDRESS							
SCL	SDA	0x60						
SDA	SCL	0x51						

A smart dual slave address provides the flexibility for the designer to connect two devices from two different slave addresses on the same I²C bus. Besides that, the two slave address options allow designers to select a different slave address if one is used by the other slave devices on the same I²C bus in a single device application.

Application Circuit With a Single Device - Slave Address 0x60

Fig. 12 shows an application circuit example with a single device. As described in Table 1, when pins 5 and 6 are connected to the clock and data signal from the microcontroller, as shown in Fig. 12, they will then be configured as an SCL pin and SDA pin, respectively. The 7 bit slave address option of 0x60 will be automatically selected.

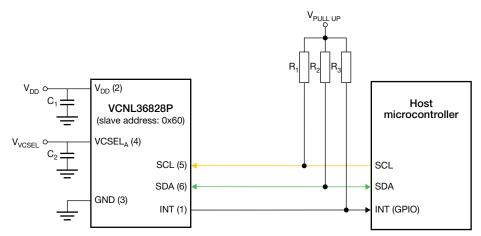


Fig. 12 - Application Circuit Example for a Single VCNL36828P - Slave Address 0x60



Application Circuit With a Single Device - Slave Address 0x51

On the other hand, when pins 5 and 6 are connected to the data and clock signal from the microcontroller, as shown in Fig. 13, they will then be configured as an SDA pin and SCL pin, respectively. The 7 bit slave address option of 0x51 will be automatically selected.

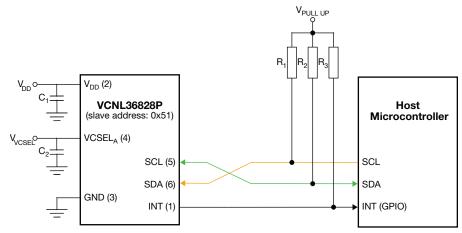


Fig. 13 - Application Circuit Example for a Single VCNL36828P - Slave Address 0x51

Table 2 shows the required values and the explanation for the individual application circuit parameters.

TABLE 2 - A	TABLE 2 - APPLICATION CIRCUIT PARAMETERS								
CIRCUIT PARAMETER	VALUE	DESCRIPTION							
V _{DD}	1.65 V to 2.00 V	A stable power supply such as a low dropout regulator or a switching regulator is required; the power supply isolation can be further improved with a decoupling capacitor C ₁							
V _V CSEL	2.62 V to 3.60 V	A stable power supply such as a low dropout regulator or a switching regulator that can supply an adequate amount of power (max. VCSEL pulse driving current of 20 mA) is required; the power supply isolation can be further improved with a decoupling capacitor C ₂ ; the minimum voltage depends on the selected driving current of the VCSEL; please refer to Table V _{VCSEL, min.} for reference							
V _{PULL UP}	1.2 V to 3.6 V	A stable power supply such as a low dropout regulator or a switching regulator is required; a voltage level shifter is required if the I ² C bus voltage from the microcontroller is higher than 3.6 V							
C ₁ - C ₄	100 nF to 1 μF	Decoupling capacitors are recommended to reduce the noise in the supply voltage							
R ₁ - R ₂	2.2 kΩ to 4.7 kΩ	Pull-up resistors within the range of 2.2 k Ω to 4.7 k Ω are recommended; any increase in bus capacitance or resistance will increase the logic high transition time							
R ₃	$4.7 \text{ k}\Omega$ to $22 \text{ k}\Omega$	Pull-up resistor within the range of 4.7 k Ω to 22 k Ω is recommended							



Application Circuit With a Smart Dual Slave Address

Fig. 14 shows an application circuit example with a smart dual slave address. By swapping the SCL and SDA pins of the second device, as shown in Table 1, the designer can change the 7 bit slave address of the VCNL36828P. This provides the flexibility for the designer to connect two devices from two different slave addresses on the same I²C bus.

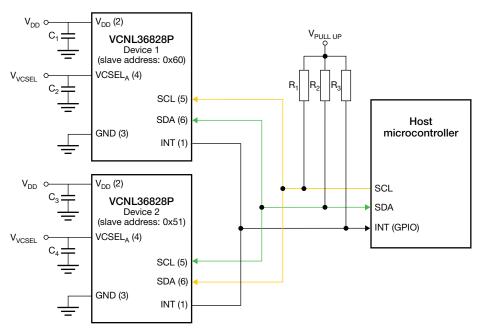


Fig. 14 - Application Circuit Example for Two VCNL36828Ps - Smart Dual Slave Address

I²C Write and Read Protocol

The communication with the VCNL36828P can be performed via I²C. The I²C write and read protocol when communicating with the proximity sensor is shown in Fig. 15.



Fig. 15 - I²C Write and Read Protocol

It is imperative that only the restart condition for the I2C read is implemented instead of the stop and restart condition.



Function Description

TABLE 3 - COMMAND CODE AND REGISTER DESCRIPTION								
COMMAND CODE	DATA BYTE LOW / HIGH	REGISTER NAME	DEFAULT VALUE	FUNCTION	ACCESS			
	L	PS CONF1 L	0x00	Internal calibration setting				
	L	PS_CONFI_L	UXUU	Switch the sensor on / off				
0x00				High dynamic range setting				
	Н	PS_CONF1_H	0x00	Persistence setting				
				Interrupt setting				
				Measurement period setting				
	L	PS_CONF2_L	0x00	Signal strength setting (Integration time and multi-pulse)				
0x01				High gain setting				
UXUT				Sensitivity of the ADC setting				
	Н	PS_CONF2_H	0x00	Internal crosstalk cancellation setting] , , ,			
				VCSEL driving current setting	Write and read			
		I DS CONES I		L PS CONF3 L		Sensor mode setting	anarcaa	
0x02	L	PS_CONFS_L	0x00	Active force mode trigger setting				
0x02	Н	PS CONF3 H	0x00	Short measurement period setting				
	П	F3_CONF3_FI	0.00	Sunlight cancellation setting	7			
0x03	L	PS_THDL_L	0x00	Low threshold interrupt value setting (low byte)				
0x03	Н	PS_THDL_H	0x00	Low threshold interrupt value setting (high byte)				
0x04	L	PS_THDH_L	0x00	High threshold interrupt value setting (low byte)				
0X04	Н	PS_THDH_H	0x00	High threshold interrupt value setting (high byte)				
0x05	L	PS_CANC_L	0x00	Offset count cancellation value setting (low byte)				
0x05	Н	PS_CANC_H	0x00	Offset count cancellation value setting (high byte)				
0xF8	L	PS_DATA_L	0x00	Proximity output data (low byte)				
UXFO	Н	PS_DATA_H	0x00	Proximity output data (high byte)	1			
0xF9	L	Reserved	0x00 - 0xFF	Reserved				
UXF9	Н	INT_FLAG	0x00	Interrupt flag	Read only			
0xFA	L	ID_L	0x28 / 0x29	Device ID Slave address: 0x60; ID = 0x28 Slave address: 0x51; ID = 0x29]			
	Н	ID_H	0x01	Device ID	1			

Notes

[•] All of the reserved registers are used for internal test. These values must be kept constant

⁽¹⁾ The default ID depends on the connection of the SCL and SDA pins on the VCNL36828P with the SCL and SDA pins on the host MCU. If pins 5 and 6 on the VCNL36828P are connected to the SCL and SDA pins on the host, the default value will be 0x28. On the other hand, if pins 5 and 6 on the VCNL36828P are connected to the SDA and SCL pins on the host, the default value will be 0x29. Please refer to Fig. 13



Command Register Format

TABLE 4 - REGISTER NAME: PS_CONF1_L											
Bit 7	Bit 6	Bit 5	Bit 5 Bit 4 Bit 3 Bit 2 Bit 1								
PS_CAL			Reserved				PS_ON				
COMMAND (MMAND CODE 0x00										
Bit N	lame	Function		Function Bit		Bit	Value	Descr	ription		
PS	CAL	Enable / disable the internal calibration		7	0 (0b0)	Disable	(default)				
F3_	CAL	Enable / disable the	internal calibration	7	1 (0b1)	Ena	able				
Rese	Reserved Reserved		rved	6 : 1	0 (0b000000)	Should be I	kept default				
PS ON		Switch the sensor on / off		Switch the sensor on / off		PS ON Switch the sensor on / off		0	0 (0b0)		he sensor n) (default)
				1 (0b1)	Turn on t	he sensor					

TABLE 5	- REGISTER	R NAME: PS_CON	NF1_H				
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Reserved	PS_HD	PS_SP_INT	PS_SMART_PERS	PS_F	PERS	PS_	INT
COMMAND	CODE					0x00	
Bit N	Name	Fund	ction	Bit	Value	Descr	iption
Rese	erved	Rese	erved	15	0 (0b0)	Should be I	kept default
DC	HD	Enable / disable high o	dynamic range (12 bit /	14	0 (0b0)	Disable (12	bit) (default)
۲٥.	_110	16 bit) ADC o	output setting	14	1 (0b1)	Enable	(16 bit)
DQ Q	P_INT	Enable / disable the	13	0 (0b0)	Disable	(default)	
1 0_0	1 _1141	mode inter	rupt setting	10	1 (0b1)	Ena	able
DS SMA	RT PERS	Enable / disable the smart persistence		12	0 (0b0)	Disable (default)	
1 0_0WA	ITT_I LITO	setting when the inter	rupt event is triggered	12	1 (0b1)	Enable	
		Set the amount of consecutive threshold crossing events necessary to trigger			0 (0b00)	1 time (default)
DQ I	PERS			11 : 10	1 (0b01)	2 times	
1 3_1	LING		rrupt	11:10	2 (0b10)	3 times	
			·		3 (0b11)	4 tir	mes
					0 (0b00)	Interrupt disable (default)	
					1 (0b01)	Logic high / low mode	
PS _.	PS_INT	Set the interrupt mode setting		9:8	2 (0b10)	threshold subsequently	he first high event and by each high / nold event
					3 (0b11)		ch high / low ld event



TABLE 6 - REGISTE	R NAME: PS_CO	NF2_L				
Bit 7 Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PS_PERIOD	PS.	_IT	PS_MPS PS_ITB			PS_GAIN
COMMAND CODE					0x01	
Bit Name	Fund	ction	Bit	Value	Description	
				0 (0b00)	50 ms, which 20 measurem	
PS_PERIOD	Sot the massu	romant pariod	7:6	1 (0b01)		translates into rements/s
	Set the measu	Set the measurement period		2 (0b10)	200 ms, which translates into 5 measurements/s	
				3 (0b11)	400 ms, which 2.5 measu	translates into rements/s
		Set the integration time for one measurement; the pulse length "T" is determined by PS ITB		0 (0b00)	1 T (d	efault)
PS IT				1 (0b01)	2 T	
F3_II				2 (0b10)	4 T	
		•		3 (0b11)	8 T	
			0 (0b00)	1 pulse	(default)	
PS MPS	Set the number of	of infrared signal	3:2	1 (0b01)	2 pulses	
F3_WF3	pulses per m	neasurement	3.2	2 (0b10)	4 pulses	
				3 (0b11)	8 pulses	
PS ITB	Set the pulse len	ath "T" for DC IT	1	0 (0b0)	T = 25 µs	(default)
P3_116	Set the pulse leng	gii i iores_ii	ı	1 (0b1)	T = 5	50 μs
PS GAIN	Set the gain	of the ADC	0	0 (0b0)	x 1 gain	(default)
FO_GAIN	Set the gain	OI THE ADO		1 (0b1)	x 2	gain

TABLE 7 -	REGISTER	NAME: PS_C	ONF2_H				
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Rese	erved	PS_SENS	PS_OFFSET	Reserved		I_VCSEL	
COMMAND C	ODE		0x01				
Bit N	lame	Fu	nction	Bit	Value	Desci	ription
Rese	erved	Re	served	15 : 14	0 (0b00)	Should be l	kept default
DC C	SENO	Cat the same	itivity of the ADC	13	0 (0b0)	Normal sensi	tivity (default)
P5_3	SENS	Set the sensitivity of the ADC		13	1 (0b1)	High sensitivity	
DS O	FFSET	Enable / disable the internal crosstalk cancellation		12	0 (0b0)	Disable (default)	
P5_01	FFSEI				1 (0b1)	Ena	able
Rese	erved	Re	served	11	0 (0b0)	Should be l	kept default
					0 (0b000)	7 mA (default)	
					1 (0b001)	9 mA	
					2 (0b010)	11 mA	
LVC	NOE!	Sat the VCSI	EL driving current	10:8	3 (0b011)	12 mA	
1_vC	I_VCSEL	Set the vosi	anving current	10.6	4 (0b100)	15 mA	
					5 (0b101)	17 mA	
					6 (0b110)	19 mA	
					7 (0b111)	20	mA



TABLE 8 - MAX	(IMUM BIT RESO	LUTION AND DI	GITAL OUTPUT O	OUNTS				
BIT	NAME	PS_IT = 1T	PS_IT = 2T	PS_IT = 4T	PS_IT = 8T			
PS_HD = 0 (12 bit)	PS_GAIN = 0 (x1 gain)		12 bit / 4095 counts					
F3_11D = 0 (12 bit)	PS_GAIN = 1 (x2 gain)	12 Dit / 4095 Counts						
PS_HD = 1 (16 bit)	PS_GAIN = 0 (x1 gain)	12 bit / 4095 counts	13 bit / 8191 counts	14 bit / 16 383 counts	15 bit / 32 767 counts			
F3_110 = 1 (10 bit)	PS_GAIN = 1 (x2 gain)	13 bit / 8191 counts	14 bit / 16 383 counts	15 bit / 32 767 counts	16 bit / 65 535 counts			

TABLE 9 -	REGISTER	NAME: PS_C	ONF3_L						
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
Rese	erved	PS_TRIG	PS_TRIG PS_MODE			Reserved			
COMMAND C	COMMAND CODE 0x02								
Bit N	lame	Fu	ınction	Bit	Value Description				
Rese	erved	Re	eserved	7:6	0 (0b00)	Should be kept default			
DQ -	TRIG	Set the active force mode trigger; This bit will be reset to 0 after		5	0 (0b0)	Off (default)			
F3_	inid		urement cycle	3	1 (0b1)	Trigger			
DC N	4ODE	Set the mea	surement mode	4	0 (0b0)	Auto mode (default)			
P5_IV	PS_MODE		of the sensor		1 (0b1)	Active force mode			
Rese	erved	Re	eserved	3:0	0 (0b0000)	Should be	kept default		

TABLE 10	- REGISTER	NAME: PS_	CONF3_H				
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
PS_SHOR	T_PERIOD	Reserved	PS_SC			Rese	erved
COMMAND CO	ODE					0x02	
Bit N	ame	Fu	nction	Bit	Value	Desci	ription
					0 (0b00)	(follow PS_PE	short period ERIOD setting) ault)
PS_SHOR	PS_SHORT_PERIOD		Set the short measurement period		1 (0b01)	6.25 ms, which translates int 160 measurements/s	
					2 (0b10)	12.5 ms, which translates int 80 measurements/s	
					3 (0b11)	25 ms, which translates into 40 measurements/s	
Rese	erved	Re	served	13	0 (0b0)	Should be	kept default
500	PS_SC		Enable / disable the sunlight cancellation		0 (0b000)	Disable	(default)
PS_					7 (0b111)	Ena	able
Rese	erved	Re	served	9:8	0 (0b00)	Should be	kept default



TABLE 11	TABLE 11 - REGISTER NAME: PS_THDL								
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
	PS_THDL_L								
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
			PS_THD	L_H					
COMMAND C	ODE					0x03			
Bit N	lame	Fu	ınction	Bit	Value	Description			
PS_TI	HDL_L	Sot the low thro	Set the low threshold interrupt value		0 to 65 535	Low byte			
PS_TI	HDL_H	Set the low thre			0 10 05 555	High byte			

TABLE 12	TABLE 12 - REGISTER NAME: PS_THDH								
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PS_THDH_L									
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
			PS_THDI	H_H					
COMMAND C	ODE					0x04			
Bit N	Name	Fu	Function		Value	Desc	ription		
PS_T	HDH_L	Set the high threshold interrupt value —		7:0	0 to 65 535	Low byte			
PS_TI	HDH_H			15:8	0 10 05 555	High byte			

TARIF 13	- REGISTER	R NAME: PS	CANC						
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
	1		PS_CAN	C_L			- I		
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
Reserved					PS_CANC_H				
COMMAND C	ODE					0x05			
Bit I	Name	Fu	ınction	Bit	Value	Desc	ription		
PS_C	ANC_L	Set t	the offset	7:0	0 to 4095	Low byte			
PS_C	PS_CANC_H count cancellation value		11 : 8	0 10 4095	High byte				
Res	erved	Re	served	15 : 12	0 (0b0000)	Should be kept defaul			

TABLE 14	TABLE 14 - REGISTER NAME: PS_DATA								
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PS_DATA_L									
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
			PS_DATA	A_H					
COMMAND C	ODE					0xF8			
Bit N	lame	Fu	ınction	Bit	Value	Descr	iption		
PS_D	ATA_L	Dood the pro	Read the proximity output data		0 to 65 535	Low byte			
PS_D	ATA_H	nead the pro			0 10 00 000	High byte			



		R NAME: INT						
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
			Reserv	ed				
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
	Reserved		PS_SPFLAG	Rese	erved	PS_IF_CLOSE PS_IF_AWA		
COMMAND (CODE					0xF9		
Bit	Name	Fu	ınction	Bit	Value	Descr	iption	
Res	served	Re	eserved	7:0	0x00 - 0xFF (0b00000000 - 0b11111111)	Should be I	cept default	
Res	served	Re	eserved	15 : 13	0 (0b000)	Should be I	Should be kept default	
PS SPFLAG		Read the sunlig	Read the sunlight protection mode		0 (0b0)	No sunlight protection mode interrupt event flag		
F0_0	OFT LAG	interrup	interrupt event flag		1 (0b1)	Sunlight protection mode interrupt event flag		
Res	served	Re	eserved	11 : 10	0 (0b00)	Should be kept default		
De II		Read the high	Read the high threshold crossing		0 (0b0)	No high threshold crossing interrupt event flag		
F3_IF	PS_IF_CLOSE		interrupt event flag		1 (0b1)	High threshold crossing interrup event flag		
DO 15 AWAY		Read the low	threshold crossing	8	0 (0b0)	No low threshold crossing interrupt event flag		
F9_II	PS_IF_AWAY		interrupt event flag		1 (0b1)	Low threshold crossing interrupevent flag		

TABLE 16	TABLE 16 - REGISTER NAME: ID									
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
			ID_L							
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8			
ID_H										
COMMAND C	ODE				0xFA					
Bit N	Name	Fu	ınction	Bit	Value	Desci	ription			
ır) I			7	0x28 (0b00101000)	Device with a slave address of 0x60				
ID_H		Read the device ID		7:0	0x29 (0b00101001)	Device with a slave address of 0x51				
				15 : 8	0x01 (0b0000001)	Should be kept default				



PACKAGE INFORMATION in millimeters

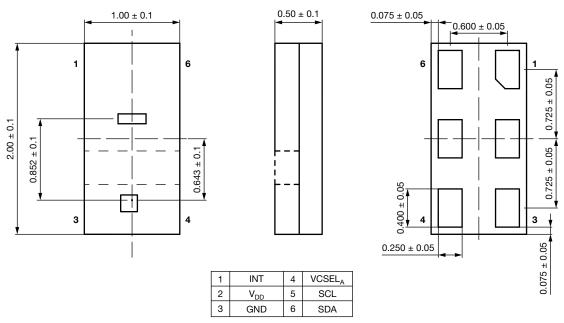


Fig. 16 - VCNL36828P Package Dimensions

RECOMMENDED LAYOUT PAD INFORMATION in millimeters

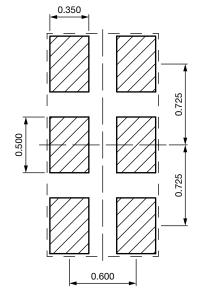


Fig. 17 - VCNL36828P PCB Layout Footprint

RECOMMENDED INFRARED REFLOW

Soldering conditions which are based on J-STD-020C

IR REFLOW PROFILE CONDITION			
PARAMETER	CONDITIONS	TEMPERATURE	TIME
Peak temperature		260 °C + 5 °C / - 5 °C (max.: 265 °C)	10 s
Preheat temperature range and timing		150 °C to 200 °C	60 s to 180 s
Timing within 5 °C to peak temperature		-	10 s to 30 s
Timing maintained above temperature / time		217 °C	60 s to 150 s
Timing from 25 °C to peak temperature		-	8 min (max.)
Ramp-up rate		3 °C/s (max.)	-
Ramp-down rate		6 °C/s (max.)	-

Recommend Normal Solder Reflow is 235 °C to 265 °C

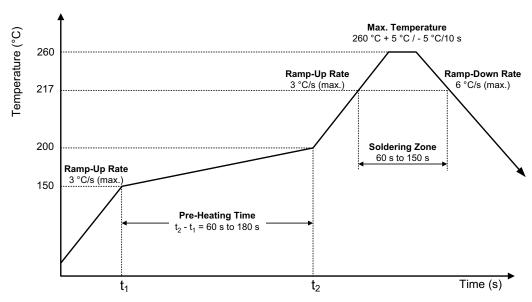
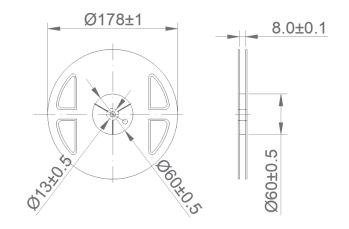
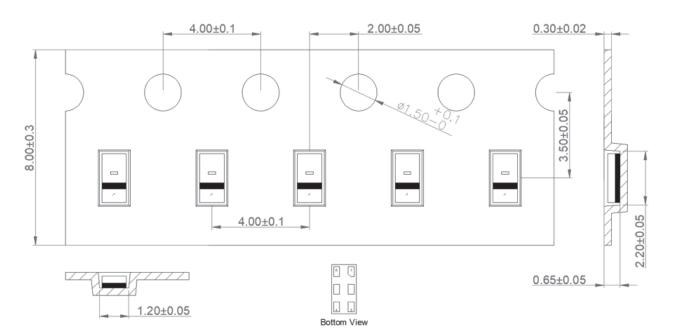


Fig. 18 - VCNL36828P Solder Reflow Profile Chart

TAPE PACKAGING INFORMATION in millimeters







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